



20V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BVDSS	R _{DS(ON)} Max	I _D Max T _C = +25°C
-20V	$3.0 \text{m}\Omega$ @ V _{GS} = -10V	-115A
	4.0mΩ @ V _{GS} = -4.5V	-105A
	7.0mΩ @ V _{GS} = -2.5V	-75A

Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Load switches
- Power management functions

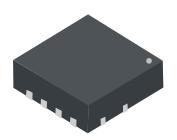
Features

- Low Rds(ON) Ensures On-State Losses Are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

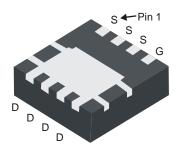
Mechanical Data

- Package: PowerDI[®]3333-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)

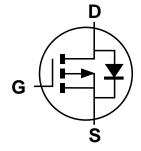




Top View



Bottom View



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Poekage	Pa	Packing			
Fait Number	Package	Qty.	Carrier			
DMP2004UFG-7	PowerDI3333-8	2,000	Tape & Reel			
DMP2004UFG-13	PowerDI3333-8	3,000	Tape & Reel			

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

Site 1:

PowerDI3333-8



YS14 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 22 = 2022) WW = Week Code (01 to 53)

Site 2:

PowerDI3333-8



YS14 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 2 = 2022) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	1	2	3	4	5	6	7	8	9	0
Week	1-26				27	'-52		53		
Code	A-Z			A-Z a-z				Z		
Internal Code	Sun	ı	Mon	Tue	W	ed	Thu	Fri		Sat
Code	Т		U	V	\	N	Х	Y		Z

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	VDSS	-20	V
Gate-Source Voltage	V_{GSS}	±12	V
Continuous Drain Current (Note 5) V _{GS} = -10V	lo	-115 -95	А
Maximum Continuous Body Diode Forward Current	Is	-2.7	Α
Pulsed Drain Current (380µs Pulse, Duty Cycle = 19	I _{DM}	-180	Α
Pulsed Body Diode Forward Current (380µs Pulse,	I _{SM}	-180	Α
Avalanche Current (Note 7) L = 0.1mH	las	-28	Α
Avalanche Energy (Note 7) L = 0.1mH	Eas	40.5	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 8)	T _A = +25°C	PD	1.0	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	$R_{\theta JA}$	124	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.4	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	52	°C/W
Total Power Dissipation (Note 5)	Tc = +25°C	PD	52	W
Thermal Resistance, Junction to Case (Note 5)		R _θ JC	2.4	°C/W
Operating and Storage Temperature Range		TJ. TSTG	-55 to +150	°C

Notes: 5. Thermal resistance from junction to soldering point (on the exposed drain pad).

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.
- 8. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

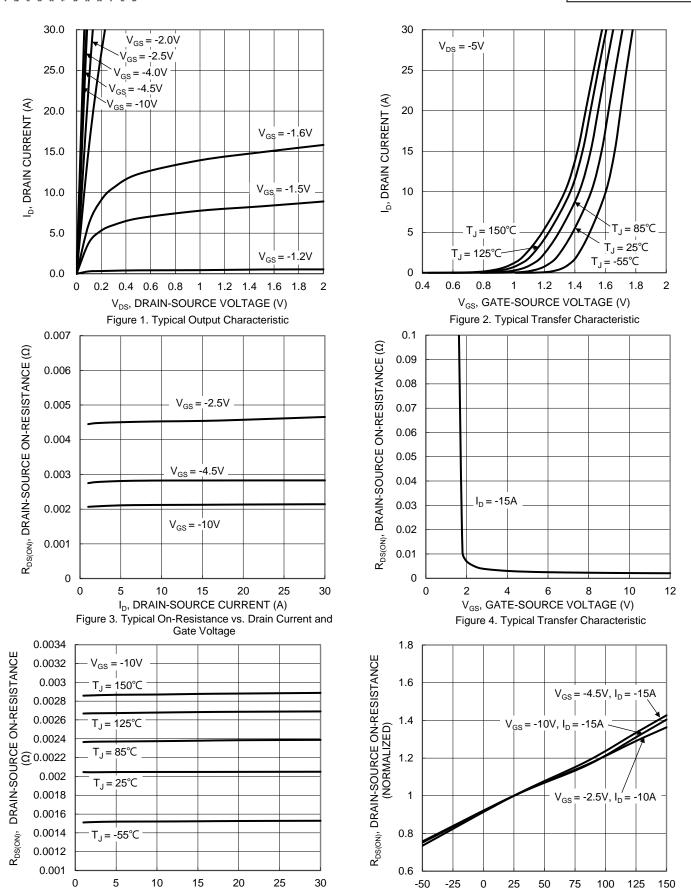


Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BVDSS	-20		_	V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current	IDSS		_	-1	μΑ	V _{DS} = -16V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	V _{GS(TH)}	-0.5		-1.1	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
			2.2	3.0		$V_{GS} = -10V, I_{D} = -15A$
Static Drain-Source On-Resistance	R _{DS(ON)}		3.0	4.0	mΩ	$V_{GS} = -4.5V$, $I_D = -15A$
			4.8	7.0		$V_{GS} = -2.5V$, $I_{D} = -10A$
Diode Forward Voltage	VsD		-0.7	-1.2	V	V _G S = 0V, I _S = -10A
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss		3840	_		101/11/101/
Output Capacitance	Coss		772	_	pF	$V_{DS} = -10V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	589	_		
Gate Resistance	Rg	_	4.6	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	40	_		
Total Gate Charge (V _{GS} = -10V)	Qg	_	83	_	nC	\/ 40\/ I- 20A
Gate-Source Charge	Qgs	_	4.5	_	iiC	$V_{DD} = -10V, I_{D} = -20A$
Gate-Drain Charge	Qgd	_	14	_		
Turn-On Delay Time	tD(ON)	_	8.2	_		
Turn-On Rise Time	t _R	_	7.3	_		$V_{GS} = -4.5V, V_{DD} = -10V$
Turn-Off Delay Time	tD(OFF)	_	75	_	ns	$R_G = 1\Omega$, $I_D = -10A$
Turn-Off Fall Time	tF	_	75.2	_		
Reverse Recovery Time	t _{RR}	_	25	_	ns	$I_F = -10A$, $dI/dt = 100A/\mu s$
Reverse Recovery Charge	QRR	_	14	_	nC	I _F = -10A, dI/dt = 100A/μs

 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:





I_D, DRAIN CURRENT (A)

Figure 5. Typical On-Resistance vs. Drain Current

and Junction Temperature

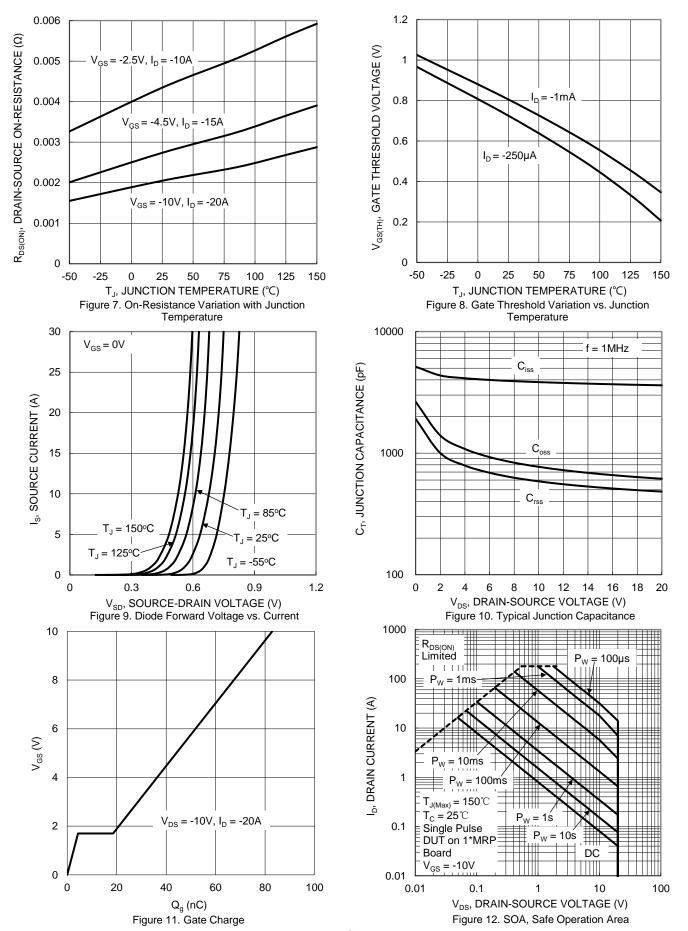
T_J, JUNCTION TEMPERATURE (°C)

Figure 6. On-Resistance Variation with Junction

Temperature









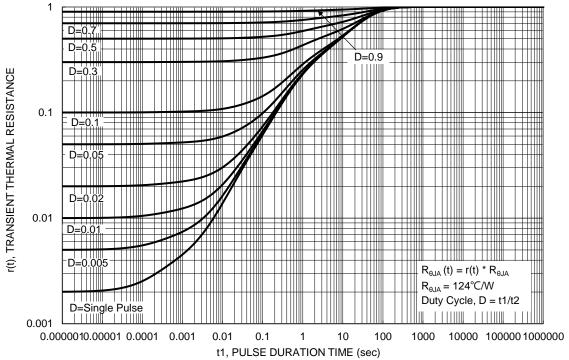


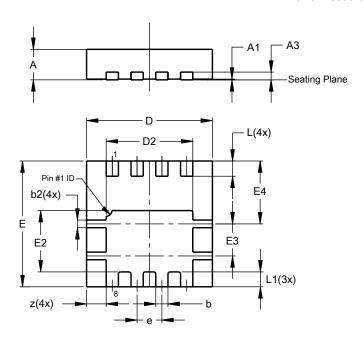
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

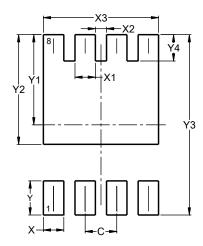


PowerDI3333-8						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
A3	_	_	0.203			
b	0.27	0.37	0.32			
b2	0.15	0.25	0.20			
D	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
Е	3.25	3.35	3.30			
E2	1.56	1.66	1.61			
E3	0.79	0.89	0.84			
E4	1.60	1.70	1.65			
е	_		0.65			
۲	0.35	0.45	0.40			
L1	_	_	0.39			
Z	_	_	0.515			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Y	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



IMPORTANT NOTICE

- 1. DIODES INCORPORATED (Diodes) AND ITS SUBSIDIARIES MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).
- 2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes' products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes' products. Diodes' products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of Diodes' products for their intended applications, (c) ensuring their applications, which incorporate Diodes' products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.
- 3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.
- 4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.
- 5. Diodes' products are provided subject to Diodes' Standard Terms and Conditions of Sale (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.
- 6. Diodes' products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes' products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.
- 7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.
- 8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.
- 9. This Notice may be periodically updated with the most recent version available at https://www.diodes.com/about/company/terms-and-conditions/important-notice

DIODES is a trademark of Diodes Incorporated in the United States and other countries. The Diodes logo is a registered trademark of Diodes Incorporated in the United States and other countries. © 2022 Diodes Incorporated. All Rights Reserved.

www.diodes.com